MSKSEMI 美森科













ESD

TV/S

TSS

MOV

GDT

PLED

MSR05

Product specification





Features

Ultra low leakage: nA level

Operating voltage: 5V

Low clamping voltage

Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±30kV Contact discharge: ±30kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

- IEC61000-4-5 (Lightning) 3A (8/20µs)

RoHS Compliant

Mechanical Characteristics

Package: SOT-143

Lead Finish: Lead Free

UL Flammability Classification Rating 94V-0

Quantity Per Reel:3,000pcs

Reel Size:7 inch

Applications

USB 2.0 power and data line

Set-top box and digital TV

Digital video interface (DVI)

Notebook Computers

SIM Ports

10/100 Ethernet

Reference News

SOT-143	PIN Configuration	Marking
	1 2	R05

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20μs)	Ррр	300	W	
ESD per IEC 61000-4-2 (Air)	V _{ESD}	±30	Kv	
ESD per IEC 61000-4-2 (Contact)		±30		
Operating Temperature Range	T₃	-55 to + 125	$^{\circ}$	
Storage Temperature Range	Тѕтл	-55 to + 150	$^{\circ}$	



Electrical Characteristics(TA=25°C unless otherwise specified)

	Vowm	V _{RWM} V _{BR} (V) (V)	h-	⊩ Vc mA) @1A	V	С	l R	С
Part Number			(mA)		(Max)	(@A)	μA (Max)	(Pf) (Typ.)
MSR05	5	6	1	9.8	23	3	1	1.2

Characteristic Curves



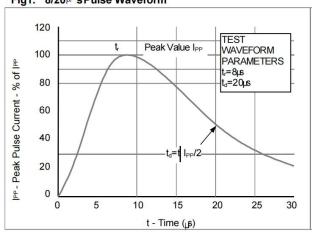


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

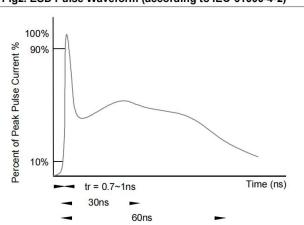
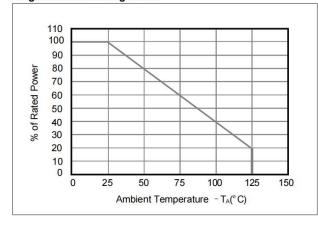
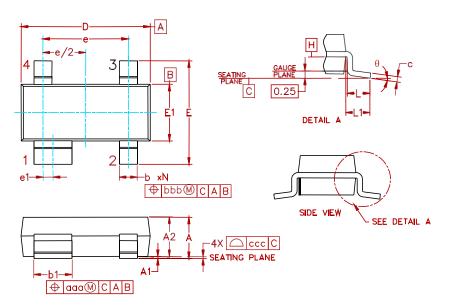


Fig3. Power Derating Curve



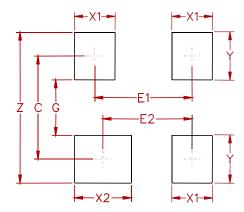


PACKAGE MECHANICAL DATA



		Inches		Millimeters			
Symbol	Min.	Min. Nom.		Min.	Nom.	Max.	
Α	0.031	-	0.048	0.80	-	1.22	
A1	0.000	-	0.008	0.013	-	0.15	
A2	0.020	0.035	0.042	0.75	0.90	1.07	
b	0.011	-	0.020	0.30	-	0.51	
b1	0.029	-	0.037	0.76	-	0.94	
С	0.003	ı	0.008	0.08	1	0.20	
D	0.110	0.114	0.120	2.80	2.90	3.04	
E	0.082	0.093	0.104	2.10	2.37	2.64	
E1	0.047	0.051	0.055	1.20	1.30	1.40	
e	0.075			1.92 BSC			
e1	0.008			0.20 BSC			
L	0.015	0.020	0.024	0.40	0.50	0.60	
L1	(0.021)			(0.54)			
N	4			4			
θ	0°	-	8°	0°	-	8°	
aaa	0.006			0.15			
bbb	0.008			0.20			
ссс	0.004				0.10		

Suggested Pad Layout



Order information

Orderable Device	Package	Packing Option
MSR05	SOT-143	3000PCS



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